# ■ MN101E01J, MN101E01K, MN101E01L, MN101E01M

Туре	MN101E01J	MN101E01K	MN101E01L	MN101E01M			
ROM (×8-bit) External memory can be expanded	192 K	256 K	320 K	384 K			
RAM (x8-bit) External memory can be expanded	10 K	10 K	14 K	20 K			
Package	QFP100-P-1818B *Lead-free	QFP100-P-1818B *Lead-free	QFP100-P-1818B *Lead-free LQFP100-P-1414 *Lead-free	QFP100-P-1818B *Lead- LQFP100-P-1414 *Lead- (under developn			
Minimum Instruction Execution Time	Standard: 0.0625 μs (at 3.0 V to 3.6 V, 32 MHz) 0.1 μs (at 3.0 V to 3.6 V, 20 MHz) 62.5 μs (at 3.0 V to 3.6 V, 32 kHz) Double speed: 0.10 μs (at 3.0 V to 3.6 V, 10 MHz)						
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 • External 5 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 5 • Timer 6 • Timer 7 (2 systems) • Time base • Serial 0 (2 systems) • Serial 1 (2 systems) • Serial 2 • Serial 3 • Serial 4 (2 systems) • Automatic transfer finish • A/D conversion finish • Key interrupts (8 lines)  Timer counter 0 : 8-bit × 1						
	(square-wave/8-bit PWM output, event count, generation of remote control carrier, pulse width measurement, generation of real time)  Clock source						
	Timer counter 0, 1 can be cascade-connected.						
	Timer counter 2:8-bit × 1 (square-wave/8-bit PWM output, event count, synchronous output event, pulse width measurement generation of real time, serial baud rate timer)  Clock source						
	Timer counter 3: 8-bit × 1 (square-wave output, event count, generation of remote control carrier, serial baud rate timer)  Clock source						
	Timer counter 2, 3 can be cascade-connected.						
		1/2, 1/4 of system clos	Ith measurement, serial baud rock frequency; 1/1, 1/4, 1/16, 1/6 f XI oscillation clock frequency	32, 1/64 of OSC oscillation			

frequency

Interrupt source ..... coincidence with compare register 4

Timer counter 5:8-bit  $\times$  1 (square-wave output, event count, serial baud rate timer)

Clock source ------ 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source ..... coincidence with compare register 5

**Panasonic** MAD00034HEM

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Timer Counter (Continue)	Timer counter 4, 5 can be cascade-connected.					
	Timer counter 6: 8-bit freerun timer					
	Clock source					
	Interrupt source ······ coincidence with compare register 6					
	Timer counter 7: 16-bit × 1  (square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output evevt, pulse width measurement, input capture)  Clock source					
	Interrupt source ······ coincidence with compare register 7 (2 lines)					
	Time base timer (one-minute count setting)					
	Clock source 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency Interrupt source 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency					
	Watchdog timer Interrupt source 1/65536, 1/262144, 1/1048576, 1/4194304 of system clock frequency					
DMA Controller (Automatic Data Transfer)	Max. Transfer cycles: 255 Starting factor: external request, various types of interrupt, software Transfer mode: 1-byte transfer, word transfer, burst transfer					
Serial Interface	Serial 0 : synchronous type/UART (full-duplex) × 1  Clock source					
	Serial 1: synchronous type/UART (full-duplex) × 1  Clock source					
	Serial 2 : synchronous type/single-master I <sup>2</sup> C× 1  Clock source					
	Serial 3 : synchronous type/single-master $I^2C \times I$ Clock source					
	Serial 4: synchronous type/UART (full-duplex) × 1  Clock source					
I/O Pins I/O	34 • (5 V IF port) Common use • Specified pull-up resistor available • Input/output selectable (bit unit)  50 • (3 V IF port) Common use • Specified pull-up resistor available • Input/output selectable (bit unit)					
A/D Inputs	$10$ -bit $\times$ 8-ch. (with S/H)					
D/A Outputs	8-bit × 1-ch.					
Special Ports	Buzzer output, remote control carrier signal output, high-current drive port					
ROM Correction	Correcting address designation: up to 3 addresses possible					

See the next page for electrical characteristics, pin assignment and support tool.

MAD00034HEM Panasonic

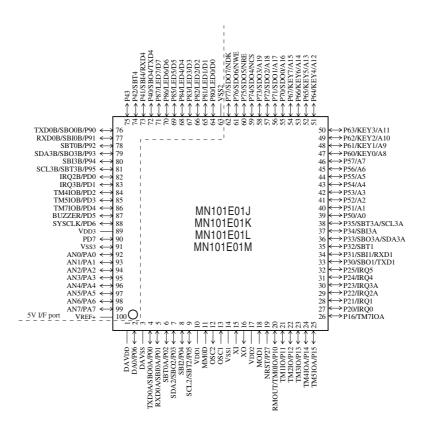
#### **Electrical Characteristics**

#### Supply current

Parameter	Symbol	Condition		Limit		
	Syllibol			typ	max	Unit
	IDD1	fosc = 4 MHz, VDD = 3 V		11(48)	30(80)	mA
Operating supply current	IDD2	fx = 32  kHz, VDD = 3  V		8(43)	22(75)	mA
	IDD3	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = 25^{\circ}\text{C}$		30(60)	120(180)	μΑ
Supply current at HALT	IDD4	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		12	30	μА
Supply current at STOP		$VDD = 3 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$		0.3	3.0	μА
Supply Cultell at STOP	IDD6	$VDD = 3 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			80	μА

( ): Flash memory built-in type.

#### Pin Assignment



QFP100-P-1818B \*Lead-free LQFP100-P-1414 \*Lead-free

Panasonic MAD00034HEM

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## **Support Tool**

In-circuit Emulator	PX-ICE101E9+PX-PRB101E01-QFP100-P-1818B PX-ICE101E9+PX-PRB101E01-QFP100-P-1414			
Flash Memory Built-in Type	Туре	MN101EF01M		
	ROM (× 8-bit) 384 K			
	RAM (× 8-bit)	24 K		
	Minimum instruction execution time	Standard: 0.0625 µs (at 3.0 V to 3.6 V, 32 MHz)		
		Double speed: $0.10~\mu s$ (at $3.0~V$ to $3.6~V$ , $10~MHz$ )		
	Package	QFP100-P-1818B *Lead-free, LQFP100-P-1414 *Lead-free		

MAD00034HEM Panasonic

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